

BCP68T1G, SBCP68T1G

NPN Silicon Epitaxial Transistor

勝特力材料 886-3-5753170
 勝特力电子(上海) 86-21-34970699
 勝特力电子(深圳) 86-755-83298787
[Http://www.100y.com.tw](http://www.100y.com.tw)



ON Semiconductor®

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This NPN Silicon Epitaxial Transistor is designed for use in low voltage, high current applications. The device is housed in the SOT-223 package, which is designed for medium power surface mount applications.

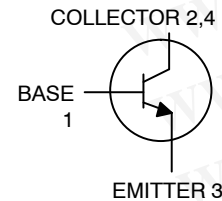
Features

- High Current: $I_C = 1.0\text{ A}$
- The SOT-223 Package Can Be Soldered Using Wave or Reflow
- SOT-223 package ensures level mounting, resulting in improved thermal conduction, and allows visual inspection of soldered joints. The formed leads absorb thermal stress during soldering, eliminating the possibility of damage to the die
- The PNP Complement is BCP69T1
- AEC-Q101 Qualified and PPAP Capable
- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant*

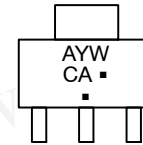
MEDIUM POWER NPN SILICON HIGH CURRENT TRANSISTOR SURFACE MOUNT



SOT-223
 CASE 318E
 STYLE 1



MARKING DIAGRAM



CA = Specific Device Code
 A = Assembly Location
 Y = Year
 W = Work Week
 ■ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

| Device | Package | Shipping† |
|-----------|-------------------|-------------------|
| BCP68T1G | SOT-223 (Pb-Free) | 1,000/Tape & Reel |
| SBCP68T1G | SOT-223 (Pb-Free) | 1,000/Tape & Reel |
| BCP68T3G | SOT-223 (Pb-Free) | 4,000/Tape & Reel |

MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

| Rating | Symbol | Value | Unit |
|---|----------------|------------|-------|
| Collector-Emitter Voltage | V_{CEO} | 20 | Vdc |
| Collector-Base Voltage | V_{CBO} | 25 | Vdc |
| Emitter-Base Voltage | V_{EBO} | 5.0 | Vdc |
| Collector Current | I_C | 1.0 | Adc |
| Total Power Dissipation @ $T_A = 25^\circ\text{C}$ (Note 1) | P_D | 1.5 | W |
| Derate above 25°C | | 12 | mW/°C |
| Operating and Storage Temperature Range | T_J, T_{stg} | -65 to 150 | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|---|-----------------|------|------|
| Thermal Resistance, Junction-to-Ambient (Surface Mounted) | $R_{\theta JA}$ | 83.3 | °C/W |
| Lead Temperature for Soldering, 0.0625 in from case | T_L | 260 | °C |
| Time in Solder Bath | | 10 | Sec |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Device mounted on a glass epoxy printed circuit board 1.575 in. x 1.575 in. x 0.059 in.; mounting pad for the collector lead min. 0.93 sq. in.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

| Characteristics | Symbol | Min | Typ | Max | Unit |
|---|----------------------|----------------|-------------|---------------|------|
| OFF CHARACTERISTICS | | | | | |
| Collector-Emitter Breakdown Voltage (I _C = 100 μAdc, I _E = 0) | V _{(BR)CES} | 25 | - | - | Vdc |
| Collector-Emitter Breakdown Voltage (I _C = 1.0 mAdc, I _B = 0) | V _{(BR)CEO} | 20 | - | - | Vdc |
| Emitter-Base Breakdown Voltage (I _E = 10 μAdc, I _C = 0) | V _{(BR)EBO} | 5.0 | - | - | Vdc |
| Collector-Base Cutoff Current (V _{CB} = 25 Vdc, I _E = 0) | I _{CBO} | - | - | 10 | μAdc |
| Emitter-Base Cutoff Current (V _{EB} = 5.0 Vdc, I _C = 0) | I _{EBO} | - | - | 10 | μAdc |
| ON CHARACTERISTICS | | | | | |
| DC Current Gain (I _C = 5.0 mAdc, V _{CE} = 10 Vdc) (I _C = 500 mAdc, V _{CE} = 1.0 Vdc) (I _C = 1.0 Adc, V _{CE} = 1.0 Vdc) | h _{FE} | 50 85 60 | - - - | - 375 - | - |
| Collector-Emitter Saturation Voltage (I _C = 1.0 Adc, I _B = 100 mAdc) | V _{CE(sat)} | - | - | 0.5 | Vdc |
| Base-Emitter On Voltage (I _C = 1.0 Adc, V _{CE} = 1.0 Vdc) | V _{BE(on)} | - | - | 1.0 | Vdc |
| DYNAMIC CHARACTERISTICS | | | | | |
| Current-Gain - Bandwidth Product (I _C = 10 mAdc, V _{CE} = 5.0 Vdc) | f _T | - | 60 | - | MHz |

TYPICAL ELECTRICAL CHARACTERISTICS

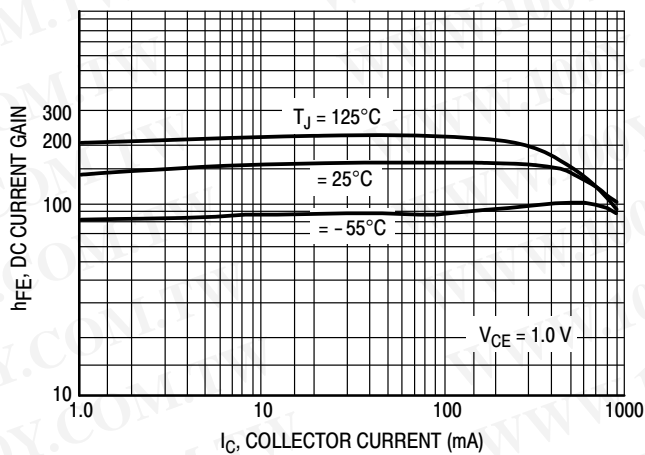


Figure 1. DC Current Gain

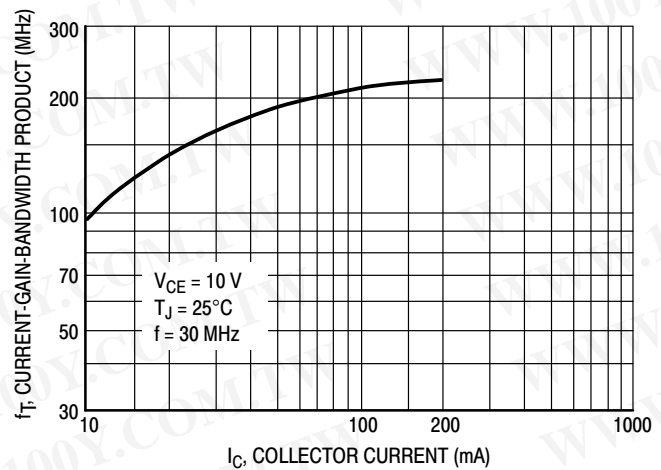


Figure 2. Current-Gain-Bandwidth Product

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TYPICAL ELECTRICAL CHARACTERISTICS

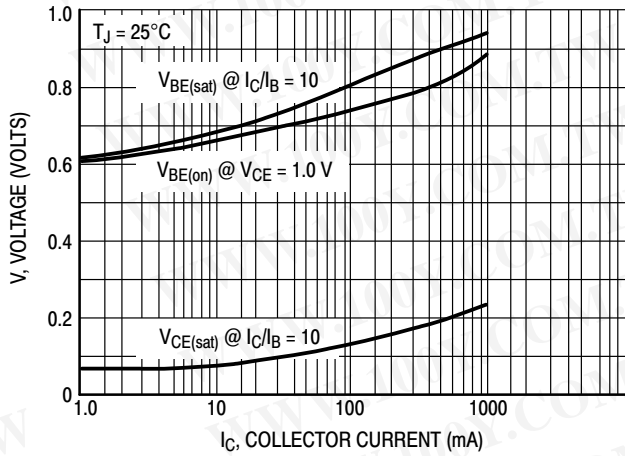


Figure 3. "On" Voltage

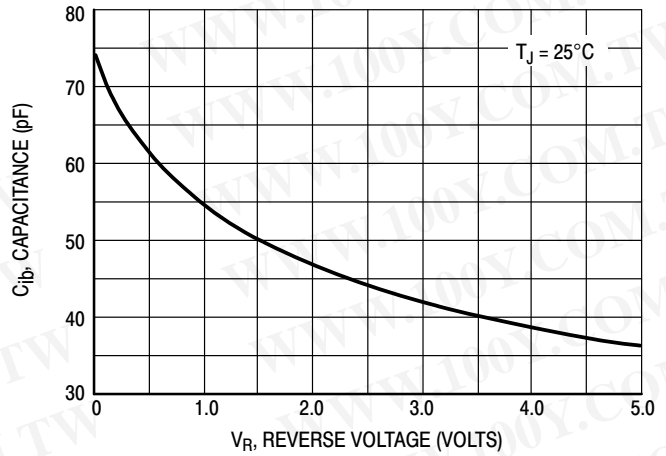


Figure 4. Capacitance

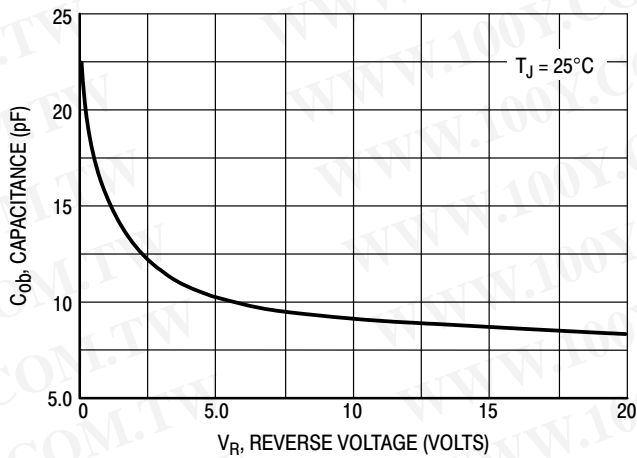


Figure 5. Capacitance

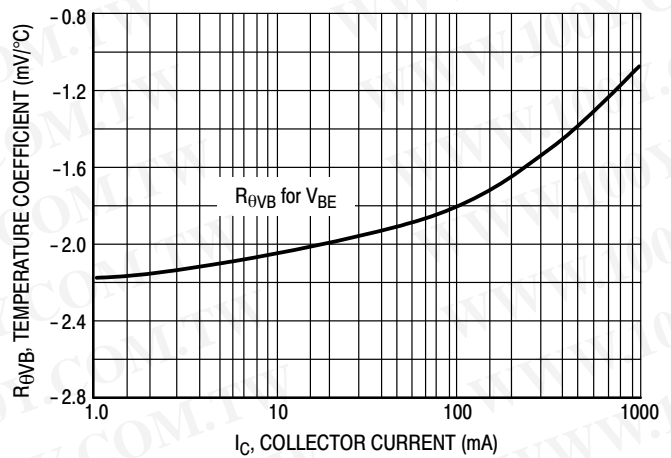


Figure 6. Base-Emitter Temperature Coefficient

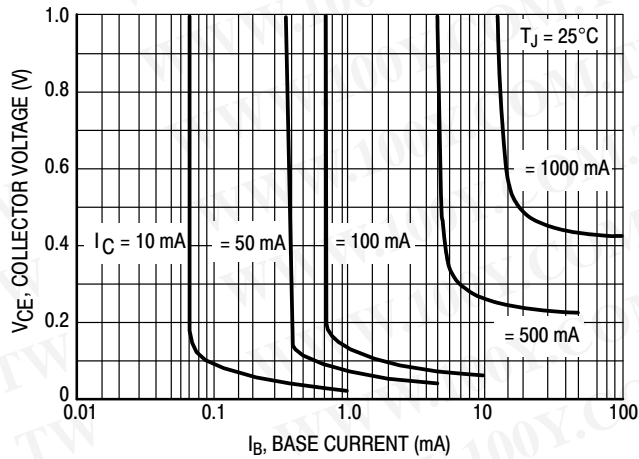


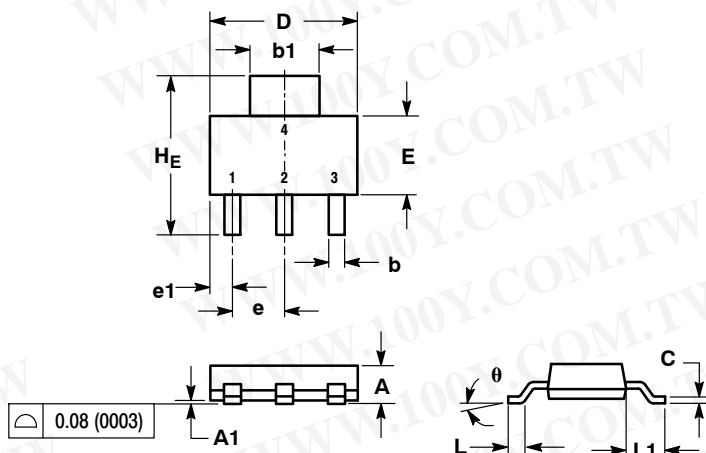
Figure 7. Saturation Region

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PACKAGE DIMENSIONS

SOT-223 (TO-261)
CASE 318E-04
ISSUE N

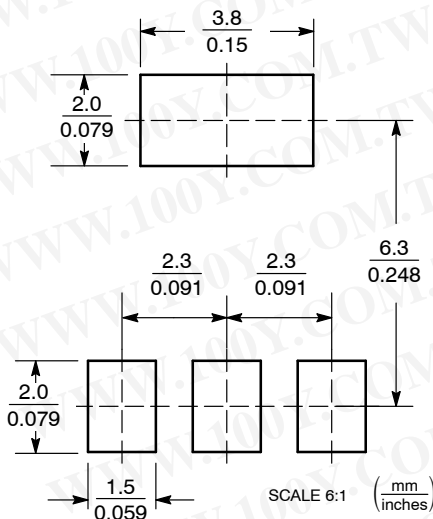


- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: INCH.

| DIM | MILLIMETERS | | | INCHES | | |
|-----|-------------|------|------|--------|-------|-------|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 1.50 | 1.63 | 1.75 | 0.060 | 0.064 | 0.068 |
| A1 | 0.02 | 0.06 | 0.10 | 0.001 | 0.002 | 0.004 |
| b | 0.60 | 0.75 | 0.89 | 0.024 | 0.030 | 0.035 |
| b1 | 2.90 | 3.06 | 3.20 | 0.115 | 0.121 | 0.126 |
| c | 0.24 | 0.29 | 0.35 | 0.009 | 0.012 | 0.014 |
| D | 6.30 | 6.50 | 6.70 | 0.249 | 0.256 | 0.263 |
| E | 3.30 | 3.50 | 3.70 | 0.130 | 0.138 | 0.145 |
| e | 2.20 | 2.30 | 2.40 | 0.087 | 0.091 | 0.094 |
| e1 | 0.85 | 0.94 | 1.05 | 0.033 | 0.037 | 0.041 |
| L | 0.20 | --- | --- | 0.008 | --- | --- |
| L1 | 1.50 | 1.75 | 2.00 | 0.060 | 0.069 | 0.078 |
| HE | 6.70 | 7.00 | 7.30 | 0.264 | 0.276 | 0.287 |
| θ | 0° | - | 10° | 0° | - | 10° |

- STYLE 1:
PIN 1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

SOLDERING FOOTPRINT*



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